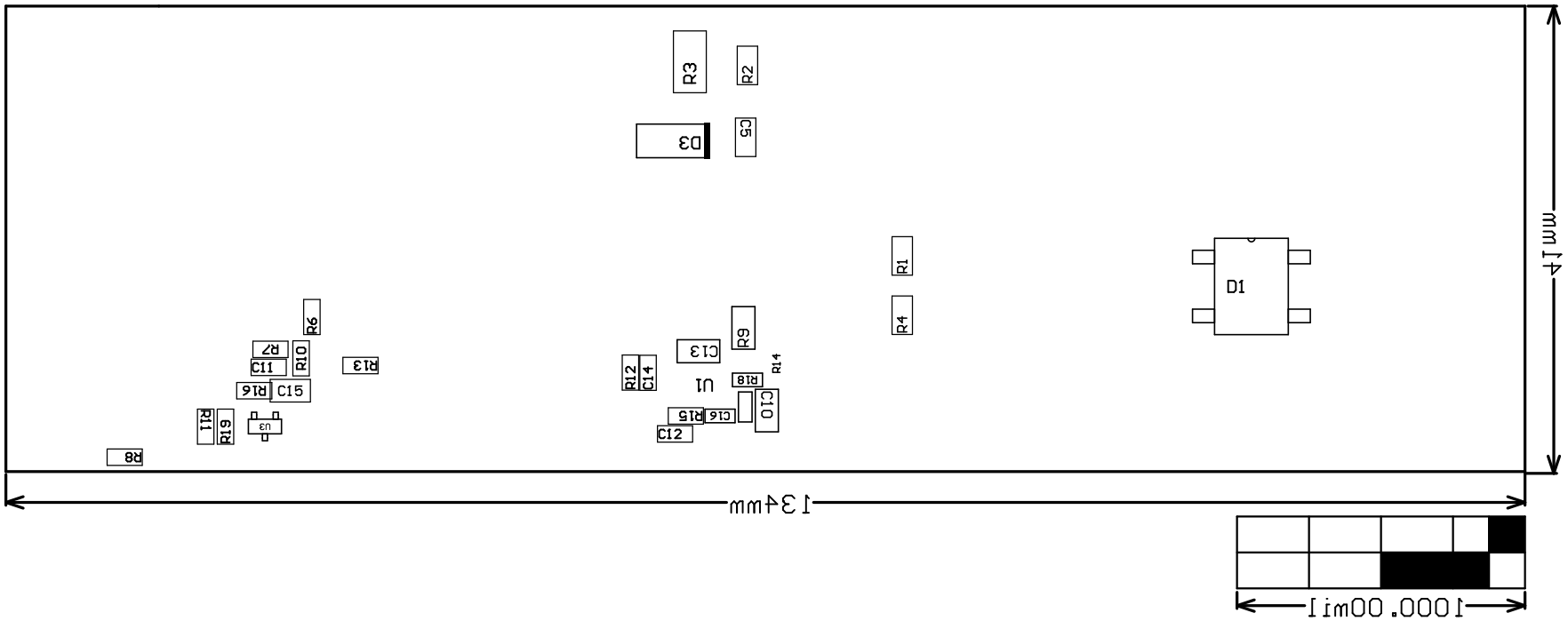


PCB VIEWED FROM TOP SIDE	BOARD #: PMP30280	REV: A	SUN REV: Not In VersionControl
M2 Board Dimensions	TID #: N/A		
PLOT NAME = Assembly Top	GENERATED : 9/4/2017	1:56:41 PM	TEXAS INSTRUMENTS



PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP30280	REV: A	SUN REV: Not In VersionControl
	TID #: N/A	<del>MS Board Owners</del>	
PLOT NAME = Assembly Bottom	GENERATED : 9/4/2017	1:56:43 PM	TEXAS INSTRUMENTS

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Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265  
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